| ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES International and Pan-Ameri | nockburn, Illinois, A | ll rights reserved untions. | Inder both | This docume evel parts, th | ent is a declaration e | ion of the su | ubstances s all lower | within the manufact level materials for | turer listed which the | item. Note: manufacture | if the item is an as er has engineering | ssembly with lowe responsibility. | |
|--|---|-----------------------------|---------------------------|---|---------------------------|---------------|---------------------------------|--|---------------------------------|----------------------------|--|--------------------------------------|--|
| | | | Form Type * Distribute | * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg | | | | | Mfg Informa | tion | | | |
| Supplier Information | | | | | | | | | | | | | |
| ompany name* Company unique ID | | | | Unique ID Authority | | | | | Respo | Response Date* | | | |
| nsemi | | | | | | | | | | 2024-05-21 | | | |
| Contact Name | Title - Contact | | |] | Phone - Contact* | | | | Email | Email - Contact* | | | |
| Product-Env-Stewards | Deduct-Env-Stewards Product Enviro Compliance | | | NA | | | | Produ | Product-Env-Stewards@onsemi.com | | | | |
| Authorized Representative* Title - Representative | | | | Phone - Representative* | | | Email | Email - Representative* | | | | | |
| Product-Env-Stewards | ro Compliance | | NA | | | Produ | Product-Env-Stewards@onsemi.com | | | | | | |
| Requester Item Number Mf | r Item Number | r Mfr Item Name | | | Effective Date | Version | Ν | Manufacturing Site | | Weight* | UOM | Unit Type | |
| SB | R80520LT3G | 0520LT3G REC SOD123 SPE | | | 2024-05-21 | | C | CN1 | | 11.67 | mg | Each | |
| Manufacturing Proccess Information | | • | | | | | <u></u> | | | | | | |
| Terminal Plating / Grid Array Material | Terminal Base | Terminal Base Alloy J-S | | Rating | Peak Process Body Tempera | | emperatur | ure Max Time at Peak Temper | | ature Num | ber of Reflow Cy | cles | |
| Matte Tin (Sn) - annealed CU Alloy | | - | 1 | | 260 | | С | 30 | seco | onds 3 | | | |
| omments | | | | | | | | | | | | | |
| vel 1 - maximum time at peak temperature duri | ng soldering is 10-3 | 0 seconds | | | | | | | | | | | |
| or more information regarding material compo | sition please refer to | page 3 | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | |
|--|--|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | | nium (Cr6+), Polybro | ominated Biphenyls (PBB), Polybron | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | on above | Supplier Acceptance | * Accepted | | | | | | |
| Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. | | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | |
| Declaration Signature | | | | | | | | | | |
| Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester. | | | | | | | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| sigma range of distribution unless otherwise noted). | | | | | | | | | |
|--|--------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|--|
| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure | |
| Die | 0.88 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.88 | mg | |
| Lead Frame | 3.19 | mg | В | Nickel (Ni) | 7440-02-0 | | 1.158 | mg | |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 1.6014 | mg | |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.4306 | mg | |
| Mold Compound-Black | 6.51 | mg | Supplier | Ortho Cresol Novolac Resin | 29690-82-2 | | 0.651 | mg | |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.0325 | mg | |
| | | | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 | | 0.9439 | mg | |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 4.2315 | mg | |
| | | | Supplier | Phenolic Resin (Novolac) | 9003-35-4 | | 0.651 | mg | |
| Plating | 0.8 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 0.8 | mg | |
| Wire Bond | 0.29 | mg | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0038 | mg | |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.2862 | mg | |